



## NPN/PNP SILICON COMPLEMENTARY SMALL SIGNAL DUAL TRANSISTOR

Qualified per MIL-PRF-19500/421

**Qualified Levels:** JAN, JANTX, and **JANTXV** 

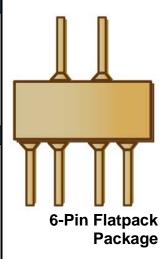
#### **DESCRIPTION**

This 2N3838 device in a 6-pin Flatpack package is military qualified up to a JANTXV level for high-reliability applications. Microsemi also offers numerous other products to meet higher and lower power voltage regulation applications.

Important: For the latest information, visit our website <a href="http://www.microsemi.com">http://www.microsemi.com</a>.

#### **FEATURES**

- JAN, JANTX, and JANTXV qualifications also available per MIL-PRF-19500/421.
- RoHS compliant versions available (commercial grade only).



#### **APPLICATIONS / BENEFITS**

- Two complementary small signal silicon transistors in a single package design.
- Lightweight.

### Also available in:



📆 TO-78 package

(leaded) 2N4854



芃 6-Pin U package (surface mount) 2N4854Ú

#### **MAXIMUM RATINGS**

Parameters/Test Conditions	Symbol	Value per		Unit
		Each	Total	
		Transistor	Package	
Thermal Resistance Junction-to-Case	Rejc	250	125	°C/W
Thermal Resistance Junction-to-Ambient	$R_{\Theta JA}$	350	290	°C/W
Total Power Dissipation @ T <sub>A</sub> = +25 °C (1)	P <sub>T</sub>	0.25	0.35	W
Total Power Dissipation @ T <sub>C</sub> = +25 °C (2)	P <sub>T</sub>	0.7	1.4	W
Junction and Storage Temperature	T <sub>J</sub> and	-65 to +200		°C
	T <sub>STG</sub>			
Collector-Base Voltage, Emitter Open	$V_{CBO}$	60		V
Emitter-Base Voltage, Collector Open	$V_{EBO}$	5		V
Collector-Emitter Voltage, Base Open	$V_{CEO}$	40		V
Collector Current, dc	Ic	600		mA
Lead to Case Voltage		+/- 120		V
Solder Temperature @ 10 s	T <sub>SP</sub>	260		°C

Notes: 1. For T<sub>A</sub> > +25 °C, derate linearly 1.43 mW/°C one transistor, 2.00 mW/°C both transistors.

2. For T<sub>C</sub> > +25 °C, derate linearly 4.0 mW/°C one transistor, 8.0 mW/°C both transistors.

#### MSC – Lawrence

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#### Website:

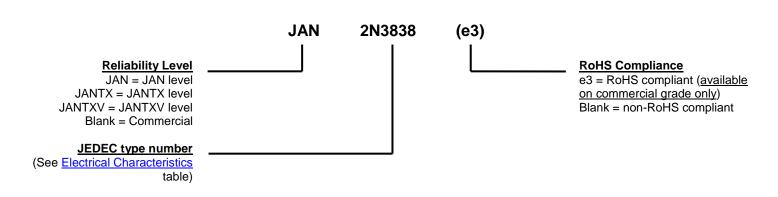
www.microsemi.com



#### **MECHANICAL and PACKAGING**

- CASE: Hermetic ceramic (white), Au over Ni plated kovar cover.
- TERMINALS: Au over Ni plated copper.
- MARKING: Manufacturer's ID, part number, date code, Pin 1 Identifier.
- POLARITY: See Case Outline.
- See <u>Package Dimensions</u> on last page.

#### **PART NOMENCLATURE**



SYMBOLS & DEFINITIONS					
Symbol	Definition				
I <sub>B</sub>	Base Current, dc.				
Ic	Collector Current, dc.				
I <sub>E</sub>	Emitter Current, dc.				
lo	Average Rectified Output Current: The Output Current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave input and a 180 degree conduction angle.				
V <sub>CB</sub>	Collector-Base Voltage (dc).				
V <sub>CE</sub>	Collector-Emitter Voltage, dc.				
V <sub>EB</sub>	Emitter-Base Voltage (dc).				

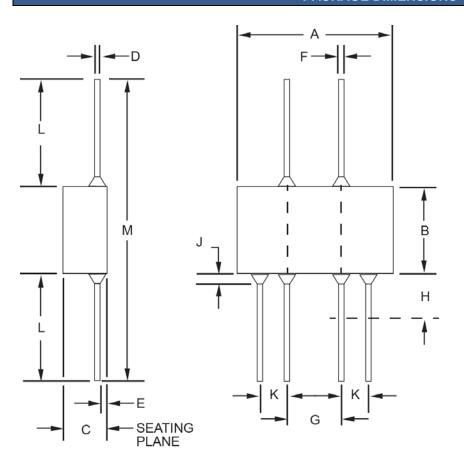


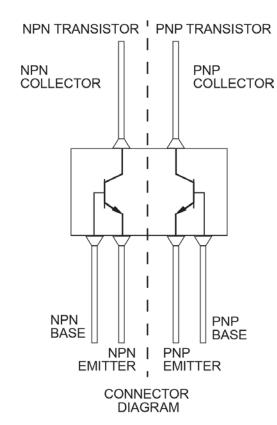
### **ELECTRICAL CHARACTERISTICS** @ T<sub>A</sub>= 25 °C unless otherwise noted.

Characteristics	Symbol	Min.	Max.	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Current	V/	40		V
$I_C = 10 \text{ mA (pulsed)}$	V <sub>(BR)CEO</sub>	40		V
Collector-Base Cutoff Current	lana		10	
V <sub>EB</sub> = 5 V	I <sub>CBO(1)</sub>		10	μΑ
Collector-Base Cutoff Current	1		F0	Λ
$V_{CB} = 50 \text{ V}$	I <sub>CBO(2)</sub>		50	nA
Emitter-Base Cutoff Current				
$V_{EB} = 5.0 \text{ V}$	I <sub>EBO(1)</sub>		10	μA
$V_{EB} = 3.0 \text{ V}$	I <sub>EBO(2)</sub>		10	nA
ON CHARACTERISTICS				
Forward-Current Transfer Ratio				
$I_C = 150 \text{ mA}, V_{CE} = 1 \text{ V}$	h <sub>FE</sub>	50		
$I_C = 100 \mu\text{A}, \ V_{CE} = 10 \text{V}$		35		
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}$		50		
$I_C = 10 \text{ mA}, V_{CE} = 10 \text{ V}$		75		
$I_C = 150 \text{ mA}, V_{CE} = 10 \text{ V}$		100	300	
$I_C = 300 \text{ mA}, V_{CE} = 10 \text{ V}$		35		
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>		0.40	V
$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	· CE(Sat)			
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	0.80	1.25	V
$I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	▼ BE(Sat)	0.00	1.20	,
DYNAMIC CHARACTERISTICS				
Forward Current Transfer Ratio	h <sub>fe</sub>	60	300	
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	rije	00	500	
Forward Current Transfer Ratio, Magnitude	h <sub>fe</sub>	2.0	10	
$I_C = 20 \text{ mA}, V_{CE} = 10 \text{ V}, f = 100 \text{ MHz}$	lilel	2.0	10	
Small-Signal Common Emitter Input Impedance	h <sub>ie</sub>	1.5	9.0	kΩ
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	1116		0.0	
Small-Signal Common Emitter Output Admittance	h <sub>oe</sub>		50	μhmo
$I_C = 1.0 \text{ mA}, V_{CE} = 10 \text{ V}, f = 1.0 \text{ kHz}$	1106			μππο
Open Circuit Output Capacitance	C <sub>obo</sub>		8.0	pF
$V_{CB} = 10 \text{ V}, I_{E} = 0, 100 \text{ kHz} \le f \le 1.0 \text{ MHz}$	0000		0.0	P.
Noise Figure	NF		8.0	dB
$I_C = 100 \mu A$ , $V_{CE} = 10 \text{ V}$ , $f = 1.0 \text{ kHz}$ , $R_G = 1.0 \text{ k}\Omega$	- 1		0.0	45
SWITCHING CHARACTERISTICS				
Turn-On Time (Saturated)	ton		45	ns
(Reference MIL-PRF-19500/421, figure 7)	OH	ļ		
Turn-Off Time (Saturated)	t <sub>off</sub>		300	ns
(Reference MIL-PRF-19500/421, figure 8)	OII	1		
Pulse Response (Non-Saturated)	ton + toff		18	ns
(Reference MIL-PRF-19500/421, figure 9)	511 . 511	1		
Collector-Emitter Non-Latching Voltage	V <sub>CEO</sub>	40		V



#### **PACKAGE DIMENSIONS**





Ltr	Dimensions				Notes
	Inch		Inch Millimeters		1
	Min	Max	Min	Max	
Α	.240	.290	6.10	7.37	
В	.115	.160	2.92	4.06	
С	.030	.080	0.76	2.03	
D	.003	.006	0.08	0.15	4
Е	.005	.035	0.13	0.89	
F	010	019	0.25	0.48	4.6

Ltr	Dimension				Notes
	Inch		Millimeters		
	Min	Max	Min	Max	
G	.100 TP		2.54 TP		6,7
Н	-	.050	-	1.27	
J	-	.015	-	0.38	5
K	.050 TP		1.27 TP		6,7
L	.070	.250	1.78	6.35	3,4
M	.260	.650	6.60	16.51	

#### NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for general information only.
- 3. Maximum limit of this dimension does not apply to device supplied in a carrier.
- 4. All six leads.
- 5. Lead dimensions are uncontrolled in this zone.
- 6. Dimensions "F", "G", and "K" to be measured in zone "H".
- 7. Leads within .005 inch (0.13 mm) total of true position (TP) at "H" with maximum material condition.
- 8. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi x$  symbology.

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